

Parameter	Rating	Units
Blocking Voltage	400	V_P
Load Current	120	mA_{rms} / mA_{DC}
On-Resistance (max)	30	Ω
LED Forward Current (to Activate)	2	mA

Features

- 1500V_{rms} Input/Output Isolation
- TTL/CMOS Compatible Input
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Immune to Radiated EM Fields
- SMD Pick & Place, Wave Solderable
- Tape & Reel Version Available
- Small 8-Pin SOIC Package

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hook Switch
 - Dial Pulsing
 - Ground Start
 - Ringing Injection
- Security
 - Passive Infrared Detectors (PIR)
 - Data Signaling
 - Sensor Circuitry
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
- Medical Equipment—Patient/Equipment Isolation
- Aerospace
- Industrial Controls

Description

The CPC2025N is a miniature device with two independent normally open (1-Form-A) solid state relays in an 8-pin SOIC package that employs optically coupled MOSFET technology to provide 1500V_{rms} of input/output isolation.

Optically coupled outputs that use the patented OptoMOS architecture are controlled by a highly efficient GaAlAs infrared LED.

The CPC2025N uses IXYS Integrated Circuits Division's state of the art, double-molded vertical construction packaging to produce one of the world's smallest relays. It offers substantial board space savings over the competitor's larger 8-Pin SOIC relay.

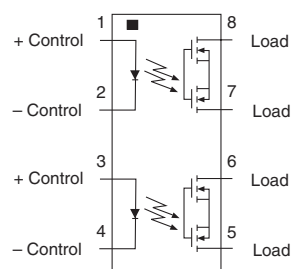
Approvals

- UL Certified Component: File E76270
- CSA Certified Component: Certificate 1172007
- EN/IEC 60950-1 Certified Component:
TUV Certificate B 10 05 49410 006

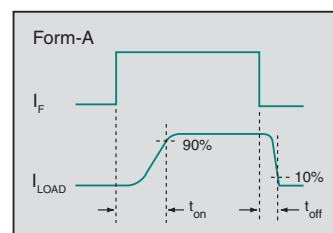
Ordering Information

Part #	Description
CPC2025N	8-Pin SOIC (50/tube)
CPC2025NTR	8-Pin SOIC (2000/reel)

Pin Configuration



Switching Characteristics of Normally Open (Form A) Devices



Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage (Peak)	400	V _P
Reverse Input Voltage	5	V
LED Forward Current Peak (10ms)	50	mA
	1	A
Input Power Dissipation	70	mW
Total Power Dissipation ¹	600	mW
Isolation Voltage, Input to Output (60 Seconds)	1500	V _{rms}
ESD Rating, Human Body Model	8	kV
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 5mW / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ 25°C

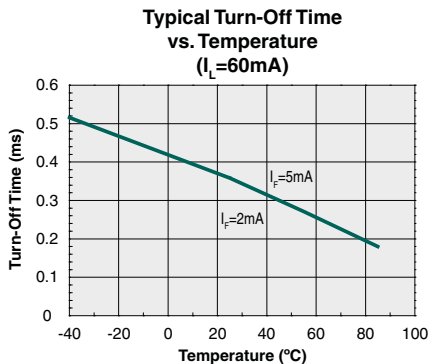
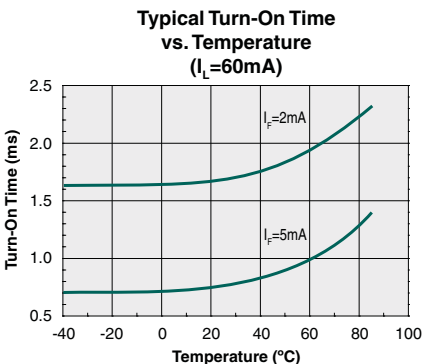
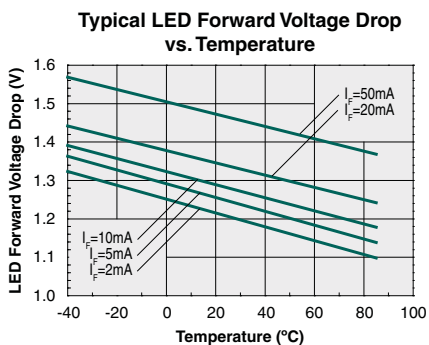
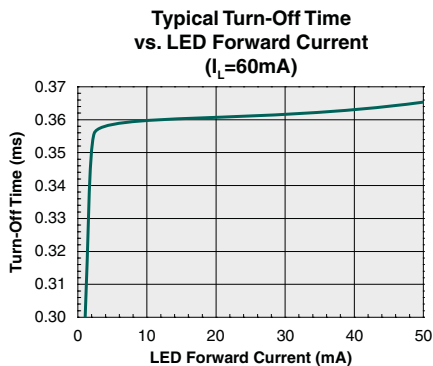
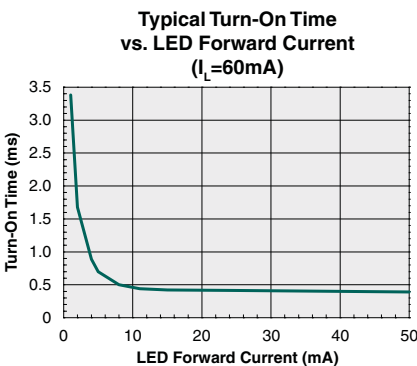
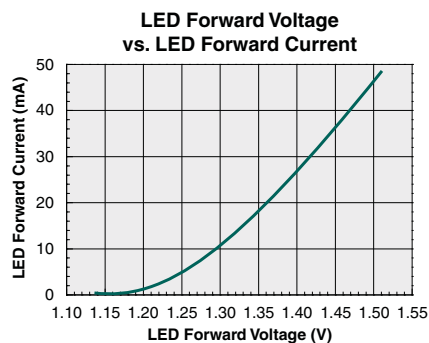
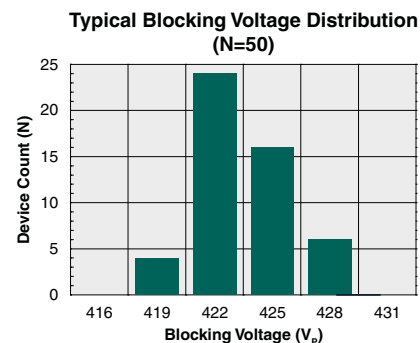
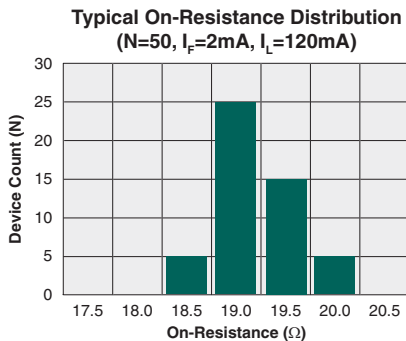
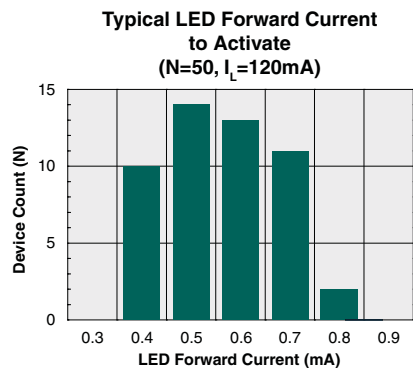
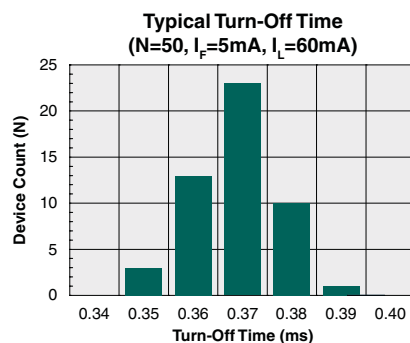
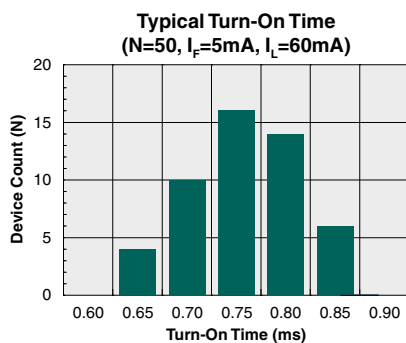
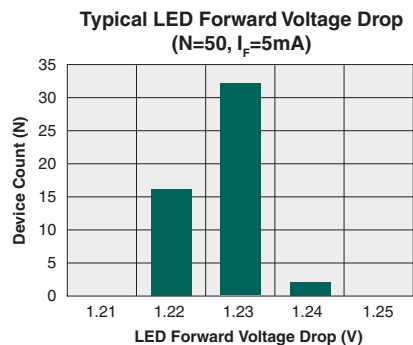
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current Continuous ¹	-	I _L	-	-	120	mA _{rms} / mA _{DC}
	t=10ms	I _{LPK}	-	-	±350	mA _P
On-Resistance ²	I _L =120mA	R _{ON}	-	20	30	Ω
Off-State Leakage Current	V _L =400V _P	I _{LEAK}	-	-	1	μA
Switching Speeds Turn-On Turn-Off	I _F =5mA, V _L =10V	t _{on}	-	0.76	2	ms
		t _{off}	-	0.36	1	
Output Capacitance	V _L =50V, f=1MHz	C _{OUT}	-	9	-	pF
Input Characteristics						
LED Forward Current To Activate ³ To Deactivate	I _L =120mA	I _F	-	0.6	2	mA
	-		0.3	0.55	-	
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics						
Capacitance, Input to Output	-	C _{I/O}	-	1	-	pF

¹ Load current derates linearly from 120mA @ 25°C to 60mA @ 85°C, and must be derated if both poles are operating simultaneously.

² Measurement taken within 1 second of on-time.

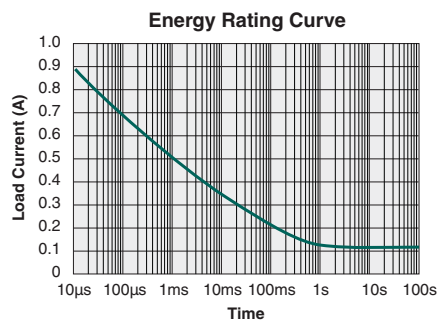
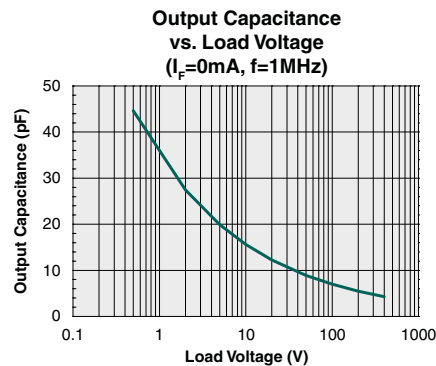
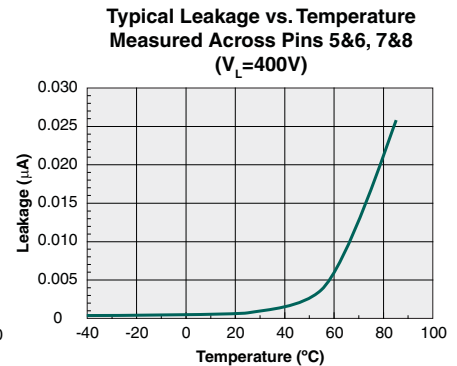
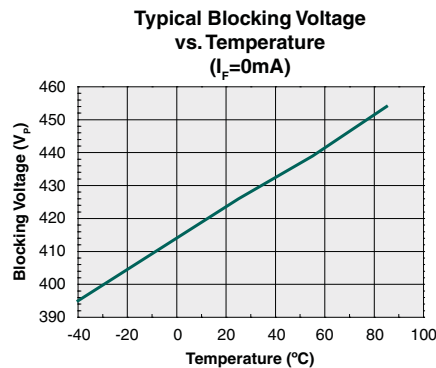
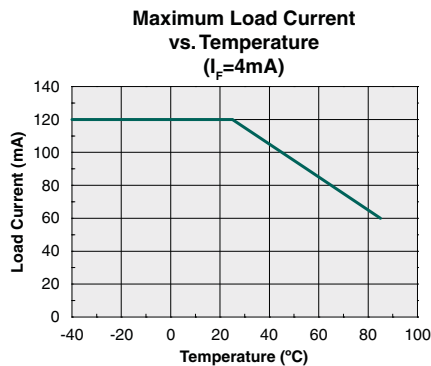
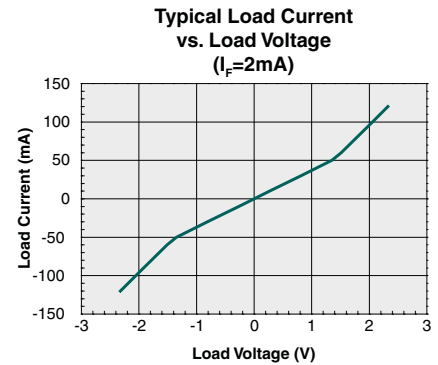
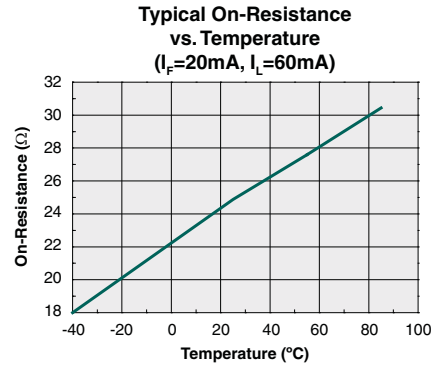
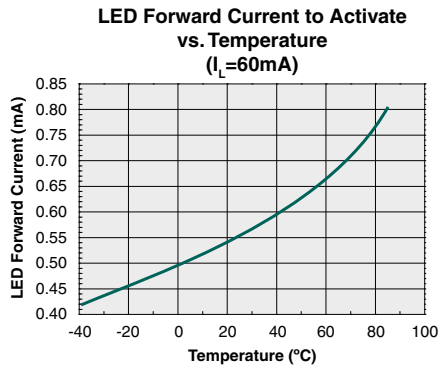
³ For applications requiring high temperature operation (greater than 60°C) a LED forward current of 4mA is recommended.

PERFORMANCE DATA @ 25°C (Unless Otherwise Noted) *



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA @ 25°C (Unless Otherwise Noted) *



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC2025N	MSL 3

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC2025N	260°C for 30 seconds

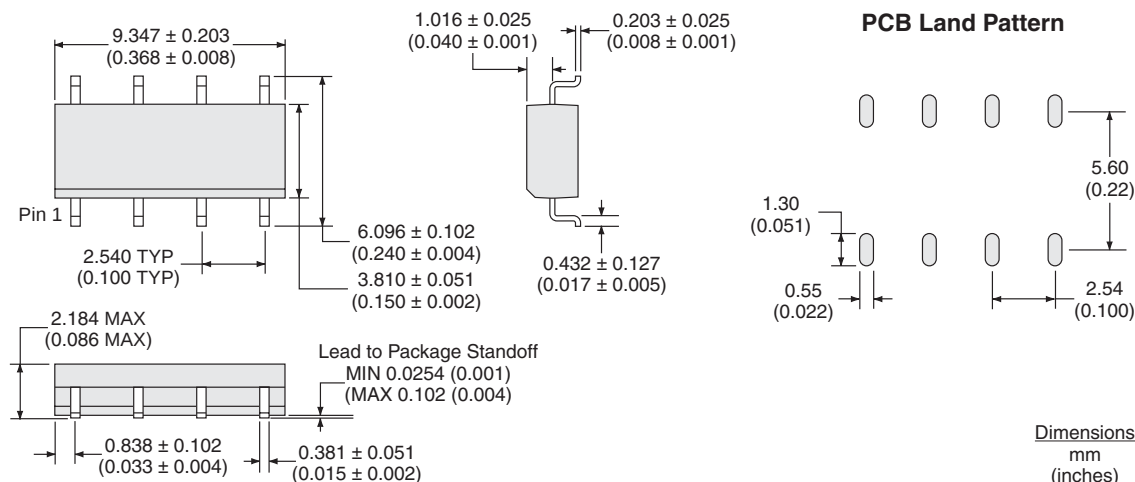
Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

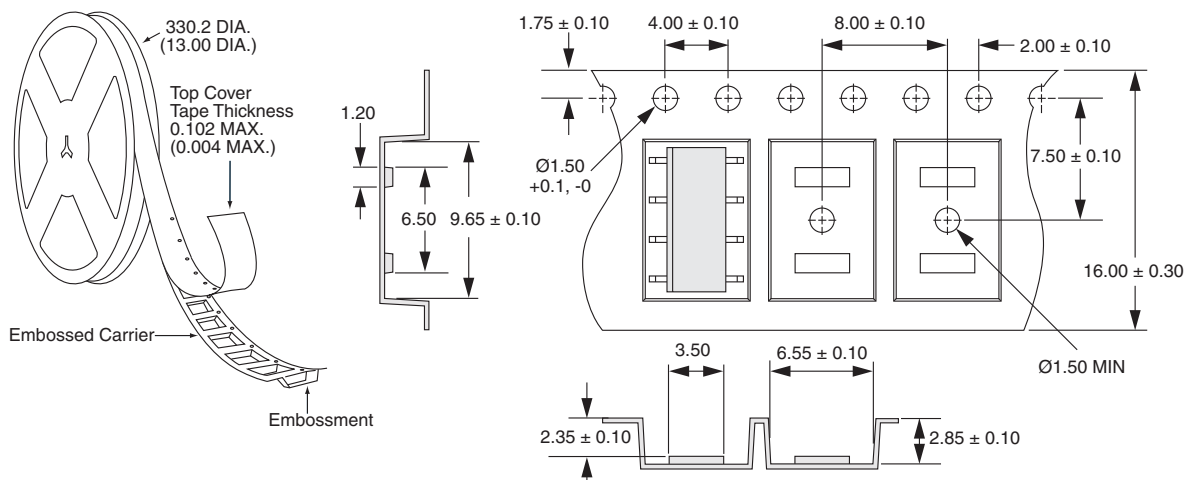


MECHANICAL DIMENSIONS

CPC2025N



CPC2025NTR Tape & Reel



NOTES:

1. All dimensions in millimeters
2. 10 sprocket hole pitch cumulative tolerance ± 0.20.
3. Carrier camber is within 1mm in 250mm.
4. Tape material : Black Conductive Polystyrene Alloy.
5. All dimensions meet EIA-481-C requirements.
6. Thickness : 0.30 ± 0.05mm.
7. Component load per 13" reel : 2000 pcs.

For additional information please visit our website at: www.ixysic.com

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Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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